

MOSFET

OptiMOS[™] 5 Power-Transistor, 25 V

Features

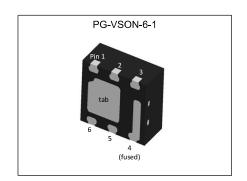
- Lowest on-resistance R_{DS(on)} in a 2x2 package
- Superior thermal resistance for a 2x2 package
 Optimized for highest performance and power density
 100% avalanche tested
- N-channel
- Pb-free lead plating; RoHS compliantHalogen-free according to IEC61249-2-21

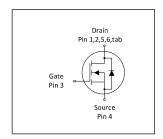
Product validation

Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

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Parameter	Value	Unit					
$V_{ t DS}$	25	V					
R _{DS(on),max}	2.4	mΩ					
I _D	55	A					
Qoss	10	nC					
Q _G (0V4.5V)	7	nC					











Type / Ordering Code	Package	Marking	Related Links
ISK024NE2LM5	PG-VSON-6-1	24E2	-

OptiMOS[™] 5 Power-Transistor, 25 V ISK024NE2LM5



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OptiMOS[™] 5 Power-Transistor, 25 V ISK024NE2LM5



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 **Maximum ratings**

Devementar	Complete I		Values	;	11	Note / Tool Openition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	-	-	55 35 20	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =4.5 V, $T_{\rm A}$ =25 °C, $R_{\rm THJA}$ =60 °C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	221	Α	T _A =25 °C
Avalanche energy, single pulse4)	E _{AS}	-	-	7	mJ	$I_{\rm D}$ =20 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-16	-	16	V	-
Power dissipation	P _{tot}	-	-	11 2.1	w	T _C =25 °C T _A =25 °C, R _{THJA} =60 °C/W ²⁾
Operating and storage temperature	T _j , T _{stg}	-55	-	150	°C	IEC climatic category; DIN IEC 68-1: 55/150/56

Thermal characteristics

at T_i=25 °C, unless otherwise specified

Table 3 Thermal characteristics

Davameter	Cymbal	Values			Unit	Note / Test Condition
Parameter	Symbol		Тур.	Max.	Onic	Note / Test Condition
Thermal resistance, junction - case, bottom	R _{thJC}	-	-	11	°C/W	-
Device on PCB, 6 cm² cooling area	R _{thJA}	-	-	60	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature at 25°C. For higher case temperature please refer to Diagram 2. De-rating will be required based on the actual

environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

OptiMOS[™] 5 Power-Transistor, 25 V ISK024NE2LM5



Electrical characteristics

at T_j=25 °C, unless otherwise specified

Static characteristics Table 4

Demonstra	C		Values			N / / T / O / I''	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition	
Drain-source breakdown voltage	V _{(BR)DSS}	25	-	-	V	V _{GS} =0 V, I _D =1 mA	
Gate threshold voltage	$V_{\rm GS(th)}$	1.2	1.6	2	V	$V_{\rm DS} = V_{\rm GS}, I_{\rm D} = 250 \ \mu {\rm A}$	
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =20 V, V _{GS} =0 V, T _j =25 °C V _{DS} =20 V, V _{GS} =0 V, T _j =125 °C	
Gate-source leakage current	I _{GSS}	-	10	100	nA	V _{GS} =16 V, V _{DS} =0 V	
Drain-source on-state resistance	R _{DS(on)}	-	1.9 2.6	2.4 3.4	mΩ	V _{GS} =10 V, I _D =20 A V _{GS} =4.5 V, I _D =20 A	
Gate resistance ¹⁾	R _G	-	0.7	1.2	Ω	-	
Transconductance	g_{fs}	-	100	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 20 A$	

Table 5 **Dynamic characteristics**

Demonstra	Comple al		Values	S	ļ., .,	
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance ¹⁾	C _{iss}	-	960	1200	pF	V _{GS} =0 V, V _{DS} =12 V, <i>f</i> =1 MHz
Output capacitance ¹⁾ C _{oss}		-	410	530	pF	V _{GS} =0 V, V _{DS} =12 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	40	70	pF	V _{GS} =0 V, V _{DS} =12 V, f=1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	7.2	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	1.6	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	14.6	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	1.6	-	ns	$V_{\rm DD}$ =12 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =20 A, $R_{\rm G,ext}$ =1.6 Ω

Gate charge characteristics²⁾ Table 6

Parameter	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Onit	Note / Test Condition
Gate to source charge	Q _{gs}	-	2.4	3.2	nC	V_{DD} =12 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate charge at threshold	Q _{g(th)}	_	1.4	1.8	nC	V_{DD} =12 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate to drain charge	Q_{gd}	-	1.5	2.3	nC	V_{DD} =12 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Switching charge	Q _{sw}	-	2.5	3.6	nC	V_{DD} =12 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate charge total	Qg	-	6.9	10.3	nC	V_{DD} =12 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate plateau voltage	V _{plateau}	-	2.4	-	V	V_{DD} =12 V, I_{D} =20 A, V_{GS} =0 to 4.5 V
Gate charge total	Q_g	-	14.8	19.7	nC	V_{DD} =12 V, I_{D} =20 A, V_{GS} =0 to 10 V
Output charge	Qoss	-	10	13.2	nC	V _{DD} =12 V, V _{GS} =0 V

¹⁾ Defined by design. Not subject to production test.
²⁾ See "Gate charge waveforms" for parameter definition. Defined by design, not subject to production test

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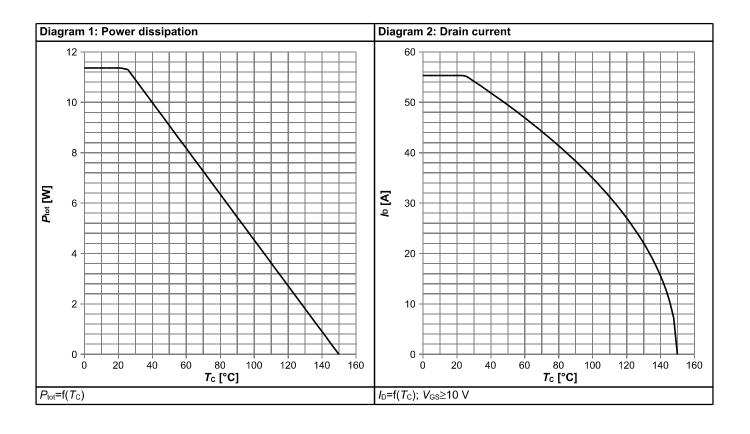


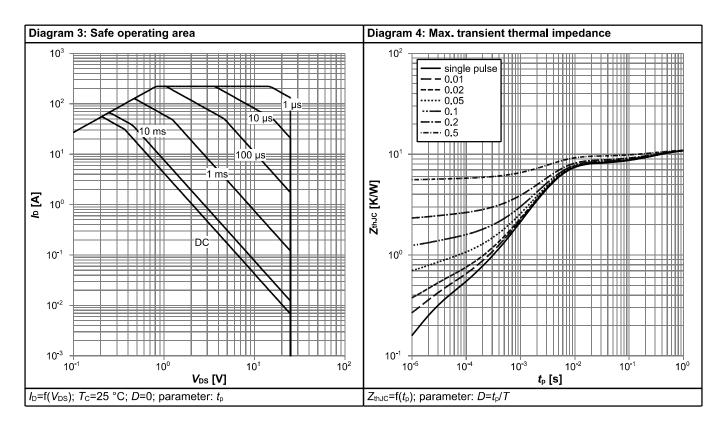
Table 7 Reverse diode

Parameter	Symbol	Values			Unit	Note / Test Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	<i>I</i> s	-	-	11	Α	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	221	Α	T _C =25 °C
Diode forward voltage	V _{SD}	-	0.81	1	V	V _{GS} =0 V, I _F =20 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	23.6	47.2	ns	V _R =12 V, I _F =20 A, d <i>i</i> _F /d <i>t</i> =100 A/μs
Reverse recovery charge ¹⁾	Q _{rr}	-	15.2	30.4	nC	V _R =12 V, I _F =20 A, d <i>i</i> _F /d <i>t</i> =100 A/μs

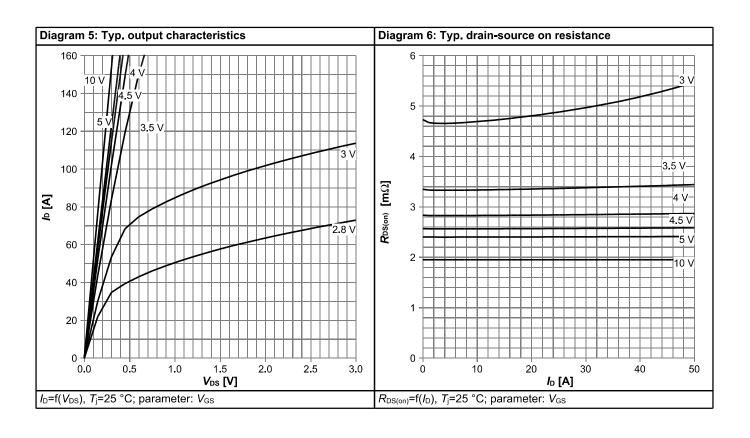


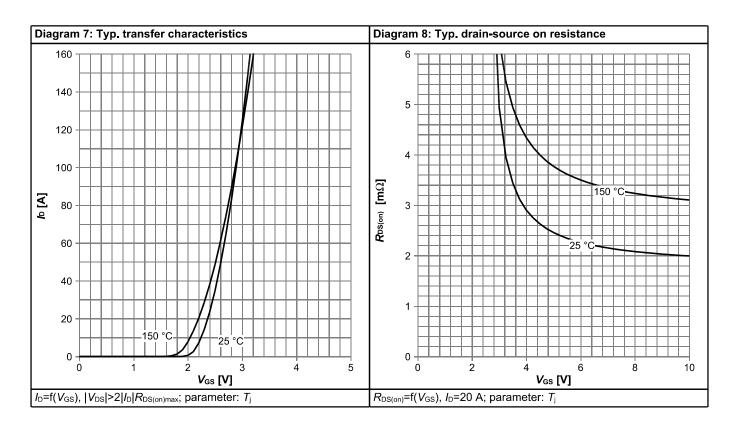
4 Electrical characteristics diagrams



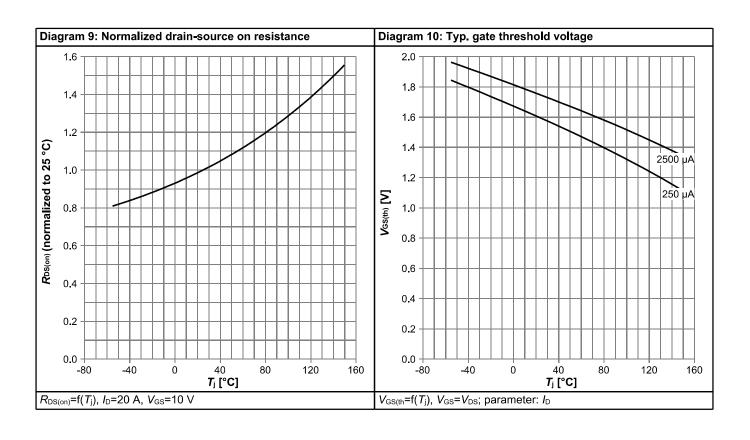


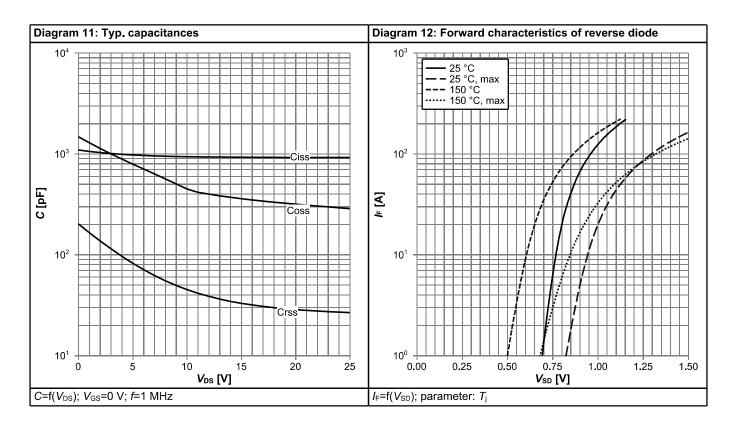




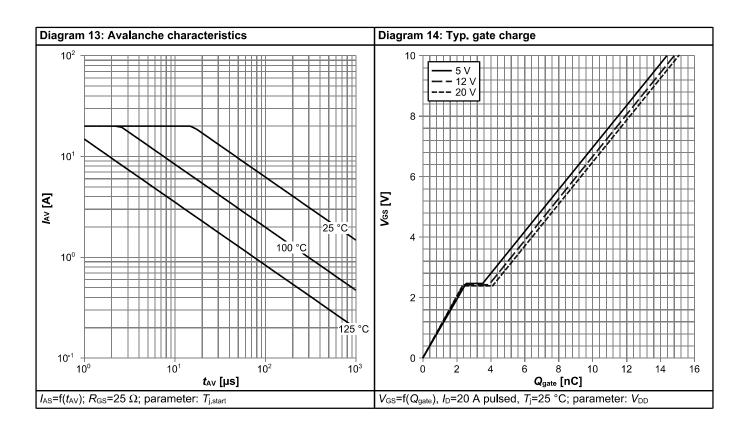


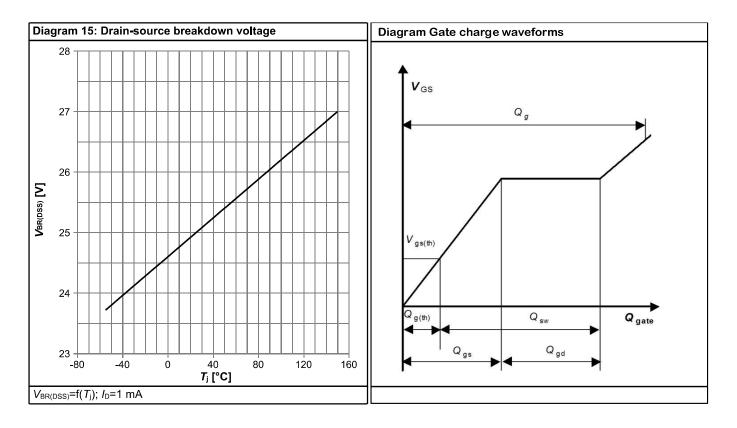






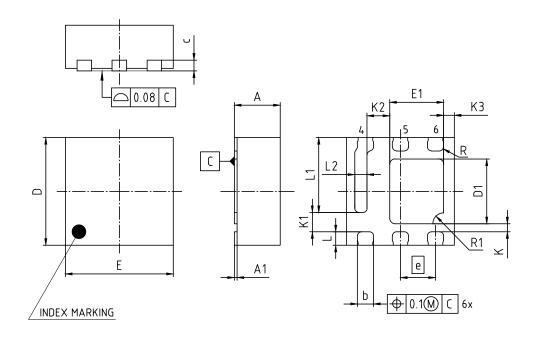








5 Package Outlines



DIMENCION	MILLIMETERS					
DIMENSION	MIN.	MAX.				
Α	-	0.90				
A 1	-	0.05				
b	0.25	0.35				
С	(1	0.20)				
D	1.90	2.10				
D1	1.10	1.30				
Е	1.90	2.10				
E1	0.90	1.10				
е	0.65					
K	0.05	-				
K 1	0.26	-				
K2	0.32	-				
К3	0.10	0.30				
L	0.20	0.30				
L1	0.10 3.70					
L2	0.13	0.33				
R	(0.08)					
R1	((0.20)				

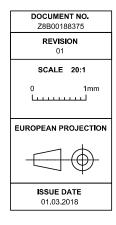


Figure 1 Outline PG-VSON-6-1, dimensions in mm

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Revision History

ISK024NE2LM5

Revision: 2020-09-14, Rev. 2.0

2020-09-14

Previous Revision					
Rev	rision	Date	Subjects (major changes since last revision)		

Trademarks

2.0

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Release of final version

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